



# MX27C4100/27C4096

4M-BIT [512K x 8/256K x 16] CMOS EPROM

## FEATURES

- 256K x 16 organization(MX27C4096, JEDEC pin out)
- 512K x 8 or 256K x 16 organization(MX27C4100, ROM pin out compatible)
- +12.5V programming voltage
- Fast access time: 100/120/150 ns
- Totally static operation
- Completely TTL compatible
- Operating current: 60mA
- Standby current: 100uA
- Package type:
  - 40 pin plastic DIP
  - 44 pin PLCC
  - 40 pin SOP

## GENERAL DESCRIPTION

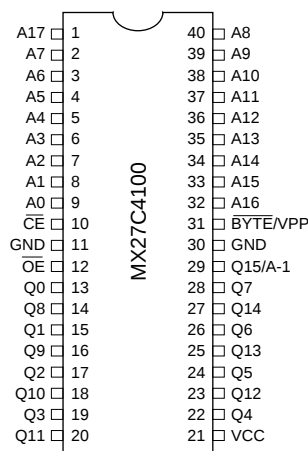
The MX27C4100/4096 is a 5V only, 4M-bit, One Time Programmable Read Only Memory. It is organized as 256K words by 16 bits per word(MX27C4096), 512K x 8 or 256K x 16(MX27C4100), operates from a single + 5 volt supply, has a static standby mode, and features fast single address location programming. All programming signals are TTL levels, requiring a single pulse. For programming outside from the system, existing EPROM

programmers may be used. The MX27C4100/4096 supports a intelligent fast programming algorithm which can result in programming time of less than two minutes.

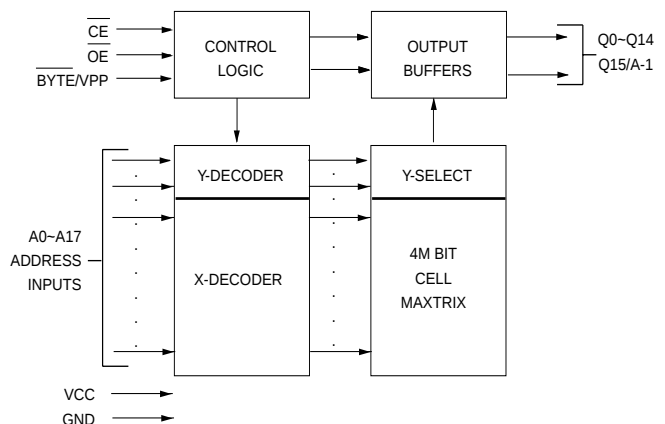
This EPROM is packaged in industry standard 40 pin dual-in-line packages, 40 lead SOP, and 44 lead PLCC packages.

## PIN CONFIGURATIONS

### SOP/PDIP(MX27C4100)

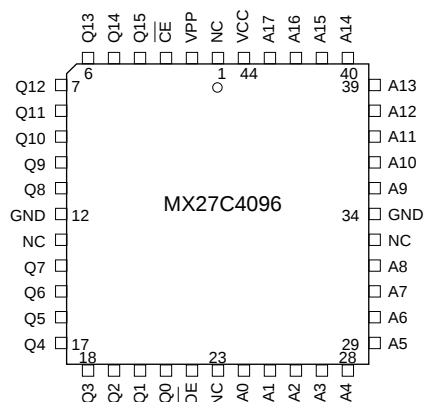


## BLOCK DIAGRAM (MX27C4100)



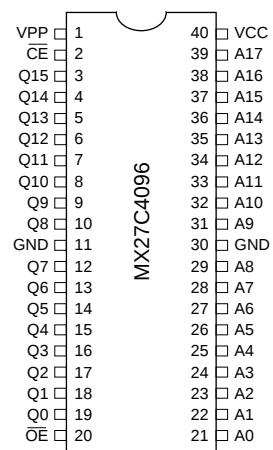
## PIN CONFIGURATIONS

### PLCC(MX27C4096)

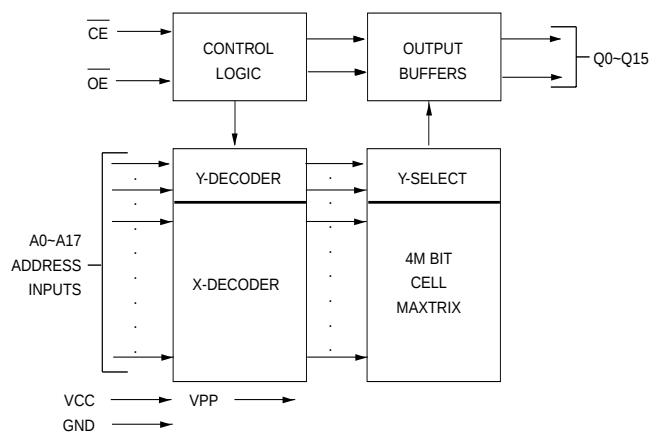


## PIN CONFIGURATIONS

### PDIP(MX27C4096)



## BLOCK DIAGRAM (MX27C4096)





# MX27C4100/27C4096

## PIN DESCRIPTION(MX27C4100)

| SYMBOL                | PIN NAME                                   |
|-----------------------|--------------------------------------------|
| A0~A17                | Address Input                              |
| Q0~Q14                | Data Input/Output                          |
| $\overline{CE}$       | Chip Enable Input                          |
| $\overline{OE}$       | Output Enable Input                        |
| $\overline{BYTE}/VPP$ | Word/Byte Selection/Program Supply Voltage |
| Q15/A-1               | Q15(Word mode)/LSB addr. (Byte mode)       |
| VCC                   | Power Supply Pin (+5V)                     |
| GND                   | Ground Pin                                 |

## PIN DESCRIPTION(MX27C4096)

| SYMBOL          | PIN NAME               |
|-----------------|------------------------|
| A0~A17          | Address Input          |
| Q0~Q15          | Data Input/Output      |
| $\overline{CE}$ | Chip Enable Input      |
| $\overline{OE}$ | Output Enable Input    |
| VPP             | Program Supply Voltage |
| VCC             | Power Supply Pin (+5V) |
| GND             | Ground Pin             |

## TRUTH TABLE OF BYTE FUNCTION(MX27C4100)

### BYTE MODE( $\overline{BYTE}$ = GND)

| $\overline{CE}$ | $\overline{OE}$ | Q15/A-1   | MODE         | Q0-Q7  | SUPPLY CURRENT  |
|-----------------|-----------------|-----------|--------------|--------|-----------------|
| H               | X               | X         | Non selected | High Z | Standby(ICC2)   |
| L               | H               | X         | Non selected | High Z | Operating(ICC1) |
| L               | L               | A-1 input | Selected     | DOUT   | Operating(ICC1) |

### WORD MODE( $\overline{BYTE}$ = VCC)

| $\overline{CE}$ | $\overline{OE}$ | Q15/A-1 | MODE         | Q0-Q14 | SUPPLY CURRENT  |
|-----------------|-----------------|---------|--------------|--------|-----------------|
| H               | X               | High Z  | Non selected | High Z | Standby(ICC2)   |
| L               | H               | High Z  | Non selected | High Z | Operating(ICC1) |
| L               | L               | DOUT    | Selected     | DOUT   | Operating(ICC1) |

NOTE : X = H or L



## FUNCTIONAL DESCRIPTION

### THE PROGRAMMING OF THE MX27C4100/4096

When the MX27C4100/4096 is delivered, or it is erased, the chip has all 4M bits in the "ONE" or HIGH state. "ZEROS" are loaded into the MX27C4100/4096 through the procedure of programming.

For programming, the data to be programmed is applied with 16 bits in parallel to the data pins.

VCC must be applied simultaneously or before VPP, and removed simultaneously or after VPP. When programming an MXIC EPROM, a 0.1uF capacitor is required across VPP and ground to suppress spurious voltage transients which may damage the device.

### FAST PROGRAMMING

The device is set up in the fast programming mode when the programming voltage  $VPP = 12.75V$  is applied, with  $VCC = 6.25V$  and  $\overline{OE} = VIH$  (Algorithm is shown in Figure 1). The programming is achieved by applying a single TTL low level 100us pulse to the  $\overline{CE}$  input after addresses and data line are stable. If the data is not verified, an additional pulse is applied for a maximum of 25 pulses. This process is repeated while sequencing through each address of the device. When the programming mode is completed, the data in all address is verified at  $VCC = VPP = 5V \pm 10\%$ .

### PROGRAM INHIBIT MODE

Programming of multiple MX27C4100/4096's in parallel with different data is also easily accomplished by using the Program Inhibit Mode. Except for  $\overline{CE}$  and  $\overline{OE}$ , all like inputs of the parallel MX27C4100/4096 may be common. A TTL low-level program pulse applied to an MX27C4100/4096  $\overline{CE}$  input with  $VPP = 12.5 \pm 0.5V$  will program the MX27C4100/4096. A high-level  $\overline{CE}$  input inhibits the other MX27C4100/4096s from being programmed.

### PROGRAM VERIFY MODE

Verification should be performed on the programmed bits to determine that they were correctly programmed.

The verification should be performed with  $\overline{OE}$  and  $\overline{CE}$  at VIL (for MX27C4096),  $\overline{OE}$  at VIL and  $\overline{CE}$  at VIH (for MX27C4100) and VPP at its programming voltage.

### AUTO IDENTIFY MODE

The auto identify mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and device type. This mode is intended for use by programming equipment for the purpose of automatically matching the device to be programmed with its corresponding programming algorithm. This mode is functional in the  $25^{\circ}C \pm 5^{\circ}C$  ambient temperature range that is required when programming the MX27C4100/4096.

To activate this mode, the programming equipment must force  $12.0 \pm 0.5V$  on address line A9 of the device. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from VIL to VIH. All other address lines must be held at VIL during auto identify mode.

Byte 0 (A0 = VIL) represents the manufacturer code, and byte 1 (A0 = VIH), the device identifier code. For the MX27C4100/4096, these two identifier bytes are given in the Mode Select Table. All identifiers for manufacturer and device codes will possess odd parity, with the MSB (Q15) defined as the parity bit.

### READ MODE

The MX27C4100/4096 has two control functions, both of which must be logically satisfied in order to obtain data at the outputs. Chip Enable ( $\overline{CE}$ ) is the power control and should be used for device selection. Output Enable ( $\overline{OE}$ ) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time ( $t_{ACC}$ ) is equal to the delay from  $\overline{CE}$  to output ( $t_{CE}$ ). Data is available at the outputs  $t_{OE}$  after the falling edge of  $\overline{OE}$ 's, assuming that  $\overline{CE}$  has been LOW and addresses have been stable for at least  $t_{ACC} - t_{OE}$ .

### WORD-WIDE MODE

With  $\overline{CE}/VPP$  at  $VCC \pm 0.2V$  outputs Q0-7 present data Q0-7 and outputs Q8-15 present data Q8-15, after  $\overline{CE}$  and  $\overline{OE}$  are appropriately enabled.



## BYTE-WIDE MODE

With  $\overline{\text{BYTE/VPP}}$  at GND  $\pm 0.2\text{V}$ , outputs Q8-15 are tri-stated. If Q15/A-1 = VIH, outputs Q0-7 present data bits Q8-15. If Q15/A-1 = VIL, outputs Q0-7 present data bits Q0-7.

used between VCC and GND for each eight devices. The location of the capacitor should be close to where the power supply is connected to the array.

## STANDBY MODE

The MX27C4100/4096 has a CMOS standby mode which reduces the maximum VCC current to 100  $\mu\text{A}$ . It is placed in CMOS standby when  $\overline{\text{CE}}$  is at VCC  $\pm 0.3\text{V}$ . The MX27C4100/4096 also has a TTL-standby mode which reduces the maximum VCC current to 1.5 mA. It is placed in TTL-standby when  $\overline{\text{CE}}$  is at VIH. When in standby mode, the outputs are in a high-impedance state, independent of the  $\overline{\text{OE}}$  input.

## TWO-LINE OUTPUT CONTROL FUNCTION

To accommodate multiple memory connections, a two-line control function is provided to allow for:

1. Low memory power dissipation,
2. Assurance that output bus contention will not occur.

It is recommended that  $\overline{\text{CE}}$  be decoded and used as the primary device-selecting function, while  $\overline{\text{OE}}$  be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low-power standby mode and that the output pins are only active when data is desired from a particular memory device.

## SYSTEM CONSIDERATIONS

During the switch between active and standby conditions, transient current peaks are produced on the rising and falling edges of Chip Enable. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. At a minimum, a 0.1  $\mu\text{F}$  ceramic capacitor (high frequency, low inherent inductance) should be used on each device between Vcc and GND to minimize transient effects. In addition, to overcome the voltage drop caused by the inductive effects of the printed circuit board traces on EPROM arrays, a 4.7  $\mu\text{F}$  bulk electrolytic capacitor should be



# MX27C4100/27C4096

## MODE SELECT TABLE (MX27C4096)

| MODE                 | PINS            |                 |     |    |     | OUTPUTS |
|----------------------|-----------------|-----------------|-----|----|-----|---------|
|                      | $\overline{CE}$ | $\overline{OE}$ | A0  | A9 | VPP |         |
| Read                 | VIL             | VIL             | X   | X  | VCC | DOUT    |
| Output Disable       | VIL             | VIH             | X   | X  | VCC | High Z  |
| Standby (TTL)        | VIH             | X               | X   | X  | VCC | High Z  |
| Standby (CMOS)       | VCC±0.3V        | X               | X   | X  | VCC | High Z  |
| Program              | VIL             | VIH             | X   | X  | VPP | DIN     |
| Program Verify       | VIH             | VIL             | X   | X  | VPP | DOUT    |
| Program Inhibit      | VIH             | VIH             | X   | X  | VPP | High Z  |
| Manufacturer Code(3) | VIL             | VIL             | VIL | VH | VCC | 00C2H   |
| Device Code(3)       | VIL             | VIL             | VIH | VH | VCC | 0151H   |

**NOTES:** 1. VH = 12.0 V ± 0.5 V  
2. X = Either VIH or VIL

3. A1 - A8 = A10 - A17 = VIL(For auto select)  
4. See DC Programming Characteristics for VPP voltage during programming.

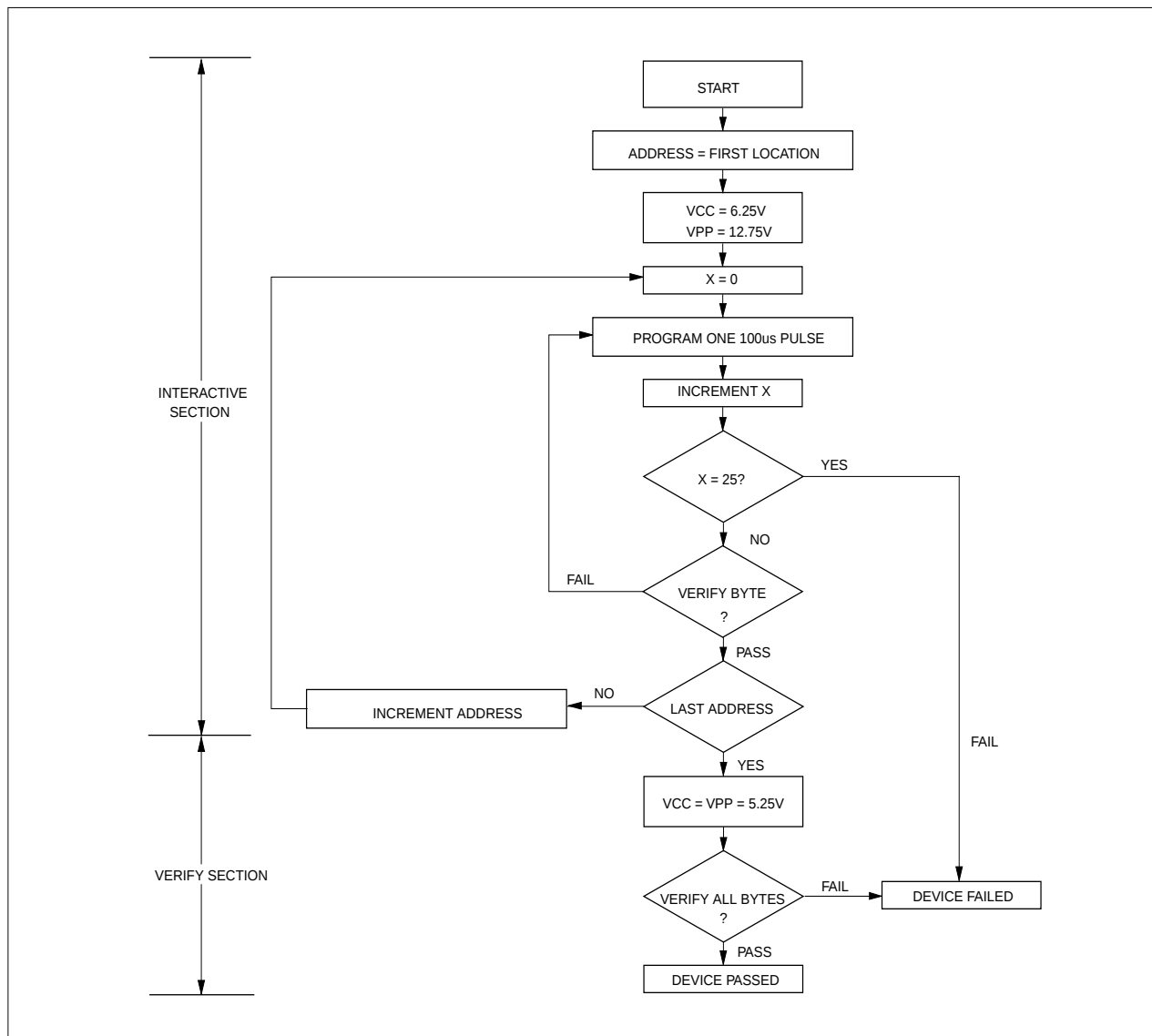
## MODE SELECT TABLE (MX27C4100)

| MODE                 | $\overline{CE}$ | $\overline{OE}$ | A9 | A0  | Q15/A-1 | $\overline{BYTE}/$ |           |           |
|----------------------|-----------------|-----------------|----|-----|---------|--------------------|-----------|-----------|
|                      |                 |                 |    |     |         | VPP(5)             | Q8-14     | Q0-7      |
| Read (Word)          | VIL             | VIL             | X  | X   | Q15 Out | VCC                | Q8-14 Out | Q0-7 Out  |
| Read (Upper Byte)    | VIL             | VIL             | X  | X   | VIH     | GND                | High Z    | Q8-15 Out |
| Read (Lower Byte)    | VIL             | VIL             | X  | X   | VIL     | GND                | High Z    | Q0-7 Out  |
| Output Disable       | VIL             | VIH             | X  | X   | High Z  | X                  | High Z    | High Z    |
| Standby              | VIH             | X               | X  | X   | High Z  | X                  | High Z    | High Z    |
| Program              | VIL             | VIH             | X  | X   | Q15 In  | VPP                | Q8-14 In  | Q0-7 In   |
| Program Verify       | VIH             | VIL             | X  | X   | Q15 Out | VPP                | Q8-14 Out | Q0-7 Out  |
| Program Inhibit      | VIH             | VIH             | X  | X   | High Z  | VPP                | High Z    | High Z    |
| Manufacturer Code(3) | VIL             | VIL             | VH | VIL | 0B      | VCC                | 00H       | C2H       |
| Device Code(3)       | VIL             | VIL             | VH | VIH | 1B      | VCC                | 38H       | 00H       |

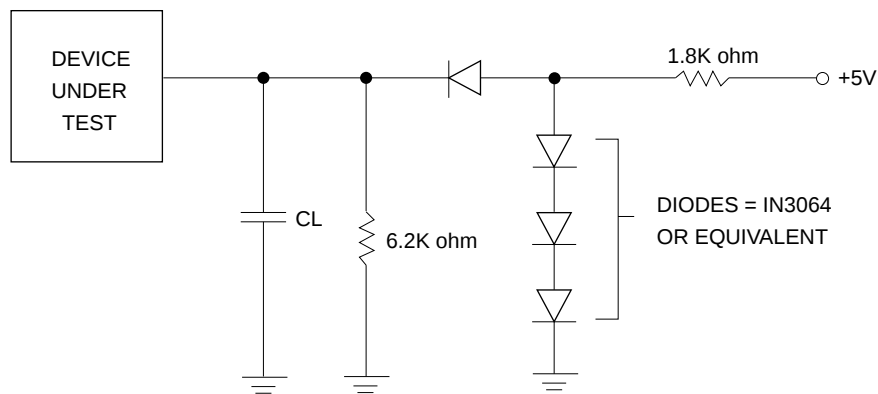
**NOTES:** 1. VH = 12.0V ± 0.5V  
2. X = Either VIH or VIL  
3. A1 - A8, A10 - A17 = VIL(for auto select)

4. See DC Programming Characteristics for VPP voltages.  
5. BYTE/VPP is intended for operation under DC Voltage conditions only.  
6. Manufacture code = 00C2H  
Device code = B800H

FIGURE 1. FAST PROGRAMMING FLOW CHART

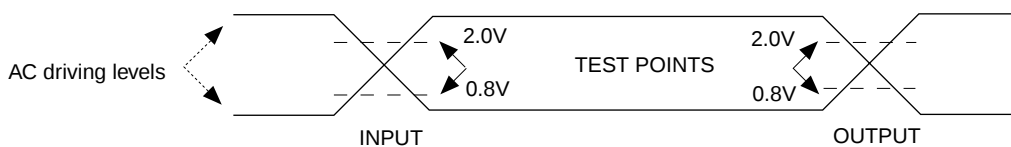


## SWITCHING TEST CIRCUITS



CL = 100 pF including jig capacitance(30pF for 100 ns parts)

## SWITCHING TEST WAVEFORMS



AC TESTING: AC driving levels are 2.4V/0.4V for commercial grade , 3.0V/0V for industrial grade.  
Input pulse rise and fall times are  $\leq 10\text{ns}$ .



AC TESTING: (1)AC driving levels are 3.0V/0V for both commercial grade and industrial grade.  
Input pulse rise and fall times are  $\leq 10\text{ns}$ .  
(2)For MX27C4100/4096-10

## ABSOLUTE MAXIMUM RATINGS

| RATING                        | VALUE               |
|-------------------------------|---------------------|
| Ambient Operating Temperature | -40°C to 85°C       |
| Storage Temperature           | -65°C to 125°C      |
| Applied Input Voltage         | -0.5V to 7.0V       |
| Applied Output Voltage        | -0.5V to VCC + 0.5V |
| VCC to Ground Potential       | -0.5V to 7.0V       |
| A9 & VPP                      | -0.5V to 13.5V      |

### NOTICE:

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended period may affect reliability.

### NOTICE:

Specifications contained within the following tables are subject to change.

## DC/AC Operating Conditions for Read Operation

|                       |            | MX27C4100/4096 |               |               |
|-----------------------|------------|----------------|---------------|---------------|
|                       |            | -10            | -12           | -15           |
| Operating Temperature | Commercial | 0°C to 70°C    | 0°C to 70°C   | 0°C to 70°C   |
|                       | Industrial | -40°C to 85°C  | -40°C to 85°C | -40°C to 85°C |
| Vcc Power Supply      |            | 5V ± 5%        | 5V ± 10%      | 5V ± 10%      |

## DC CHARACTERISTICS

| SYMBOL | PARAMETER               | MIN. | MAX.      | UNIT | CONDITIONS                                         |
|--------|-------------------------|------|-----------|------|----------------------------------------------------|
| VOH    | Output High Voltage     | 2.4  |           | V    | IOH = -0.4mA                                       |
| VOL    | Output Low Voltage      |      | 0.4       | V    | IOL = 2.1mA                                        |
| VIH    | Input High Voltage      | 2.0  | VCC + 0.5 | V    |                                                    |
| VIL    | Input Low Voltage       | -0.3 | 0.8       | V    |                                                    |
| ILI    | Input Leakage Current   | -10  | 10        | uA   | VIN = 0 to 5.5V                                    |
| ILO    | Output Leakage Current  | -10  | 10        | uA   | VOUT = 0 to 5.5V                                   |
| ICC3   | VCC Power-Down Current  |      | 100       | uA   | $\overline{CE} = VCC \pm 0.3V$                     |
| ICC2   | VCC Standby Current     |      | 1.5       | mA   | $\overline{CE} = VIH$                              |
| ICC1   | VCC Active Current      |      | 60        | mA   | $\overline{CE} = VIL$ , f=5MHz, Iout = 0mA         |
| IPP    | VPP Supply Current Read |      | 10        | uA   | $\overline{CE} = \overline{OE} = VIL$ , VPP = 5.5V |

## CAPACITANCE TA = 25°C, f = 1.0 MHz (Sampled only)

| SYMBOL | PARAMETER          | TYP. | MAX. | UNIT | CONDITIONS |
|--------|--------------------|------|------|------|------------|
| CIN    | Input Capacitance  | 8    | 12   | pF   | VIN = 0V   |
| COU    | Output Capacitance | 8    | 12   | pF   | VOUT = 0V  |
| CVPP   | VPP Capacitance    | 18   | 25   | pF   | VPP = 0V   |



# MX27C4100/27C4096

## AC CHARACTERISTICS

| SYMBOL | PARAMETER                                                                                 | 27C4100/4096-10 |      | 27C4100/4096-12 |      | 27C4100/4096-15 |      | UNIT | CONDITIONS                            |
|--------|-------------------------------------------------------------------------------------------|-----------------|------|-----------------|------|-----------------|------|------|---------------------------------------|
|        |                                                                                           | MIN.            | MAX. | MIN.            | MAX. | MIN.            | MAX. |      |                                       |
| tACC   | Address to Output Delay                                                                   |                 | 100  |                 | 120  |                 | 150  | ns   | $\overline{CE} = \overline{OE} = VIL$ |
| tCE    | Chip Enable to Output Delay                                                               |                 | 100  |                 | 120  |                 | 150  | ns   | $\overline{OE} = VIL$                 |
| tOE    | Output Enable to Output Delay                                                             |                 | 45   |                 | 50   |                 | 65   | ns   | $\overline{CE} = VIL$                 |
| tDF    | $\overline{OE}$ High to Output Float,<br>or $\overline{CE}$ High to Output Float          | 0               | 30   | 0               | 35   | 0               | 50   | ns   |                                       |
| tOH    | Output Hold from Address,<br>$\overline{CE}$ or $\overline{OE}$ which ever occurred first | 0               |      | 0               |      | 0               |      | ns   |                                       |

## AC CHARACTERISTICS(Continued)

| SYMBOL | PARAMETER              | 27C4100-10 |      | 27C4100-12 |      | 27C4100-15 |      | UNIT | CONDITIONS |
|--------|------------------------|------------|------|------------|------|------------|------|------|------------|
|        |                        | MIN.       | MAX. | MIN.       | MAX. | MIN.       | MAX. |      |            |
| tBHA   | BYTE Access Time       |            | 100  |            | 120  |            | 150  | ns   |            |
| tOHB   | BYTE Output Hold Time  | 0          |      | 0          |      | 0          |      | ns   |            |
| tBHZ   | BYTE Output Delay Time |            | 70   |            | 70   |            | 70   | ns   |            |
| tBLZ   | BYTE Output Set Time   | 10         |      | 10         |      | 10         |      | ns   |            |

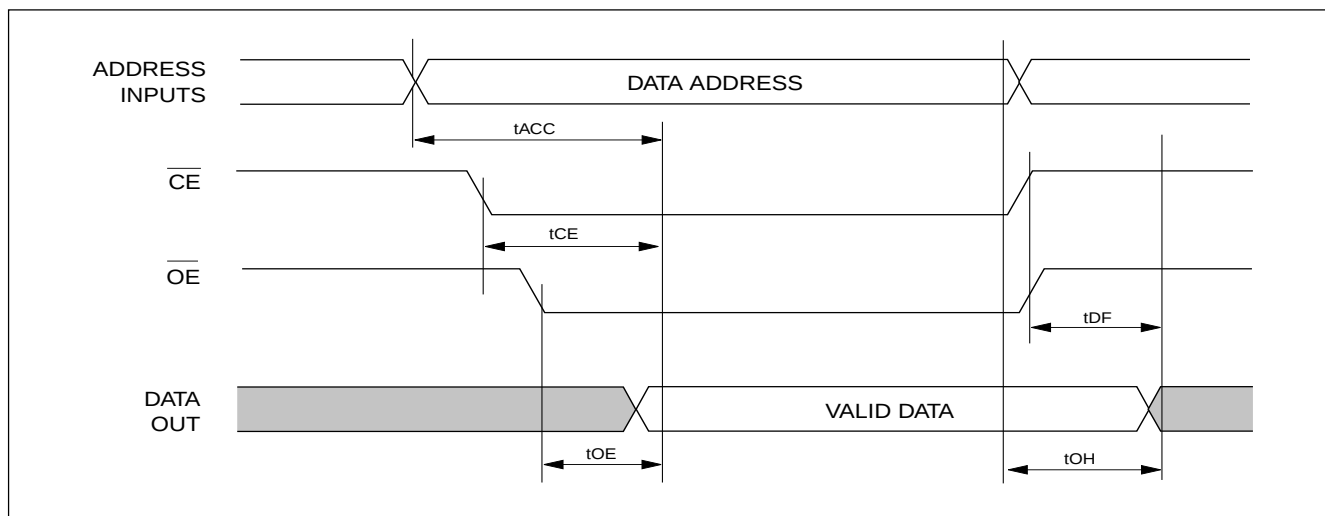
## DC PROGRAMMING CHARACTERISTICS TA = 25°C ± 5°C

| SYMBOL | PARAMETER                             | MIN. | MAX.      | UNIT | CONDITIONS                                 |
|--------|---------------------------------------|------|-----------|------|--------------------------------------------|
| VOH    | Output High Voltage                   | 2.4  |           | V    | IOH = -0.40mA                              |
| VOL    | Output Low Voltage                    |      | 0.4       | V    | IOL = 2.1mA                                |
| VIH    | Input High Voltage                    | 2.0  | VCC + 0.5 | V    |                                            |
| VIL    | Input Low Voltage                     | -0.3 | 0.8       | V    |                                            |
| ILI    | Input Leakage Current                 | -10  | 10        | uA   | VIN = 0 to 5.5V                            |
| VH     | A9 Auto Select Voltage                | 11.5 | 12.5      | V    |                                            |
| ICC3   | VCC Supply Current (Program & Verify) |      | 50        | mA   |                                            |
| IPP2   | VPP Supply Current(Program)           |      | 30        | mA   | $\overline{CE} = VIL, \overline{OE} = VIH$ |
| VCC1   | Fast Programming Supply Voltage       | 6.00 | 6.50      | V    |                                            |
| VPP1   | Fast Programming Voltage              | 12.5 | 13.0      | V    |                                            |

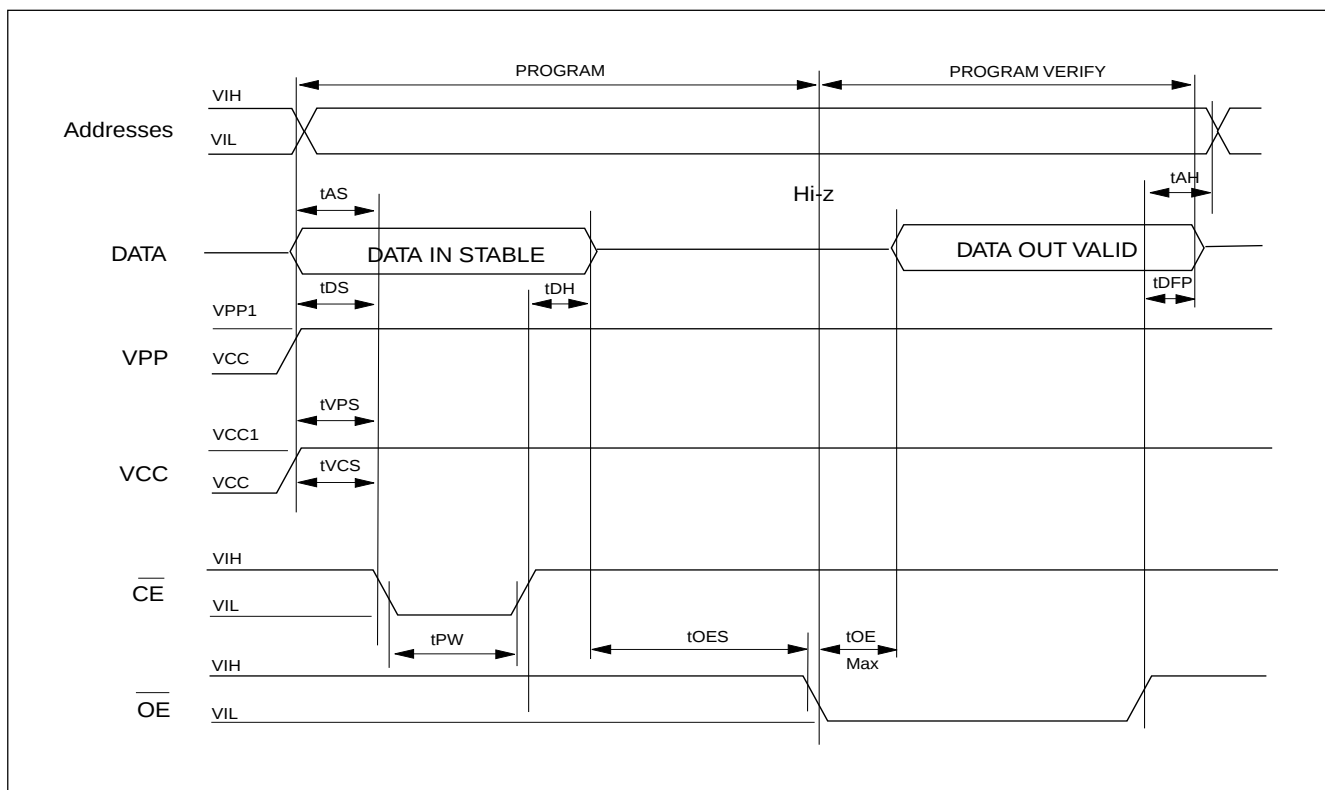
## AC PROGRAMMING CHARACTERISTICS TA = 25°C ± 5°C

| SYMBOL | PARAMETER                           | MIN. | MAX. | UNIT | CONDITIONS |
|--------|-------------------------------------|------|------|------|------------|
| tAS    | Address Setup Time                  | 2.0  |      | us   |            |
| tOES   | $\overline{OE}$ Setup Time          | 2.0  |      | us   |            |
| tDS    | Data Setup Time                     | 2.0  |      | us   |            |
| tAH    | Address Hold Time                   | 0    |      | us   |            |
| tDH    | Data Hold Time                      | 2.0  |      | us   |            |
| tDFP   | Output Enable to Output Float Delay | 0    | 130  | ns   |            |
| tVPS   | VPP Setup Time                      | 2.0  |      | us   |            |
| tPW    | PGM Program Pulse Width             | 95   | 105  | us   |            |
| tVCS   | VCC Setup Time                      | 2.0  |      | us   |            |
| tOE    | Data valid from $\overline{OE}$     |      | 150  | ns   |            |

## WEFORMS(MX27C4096) READ CYCLE(WORD MODE)

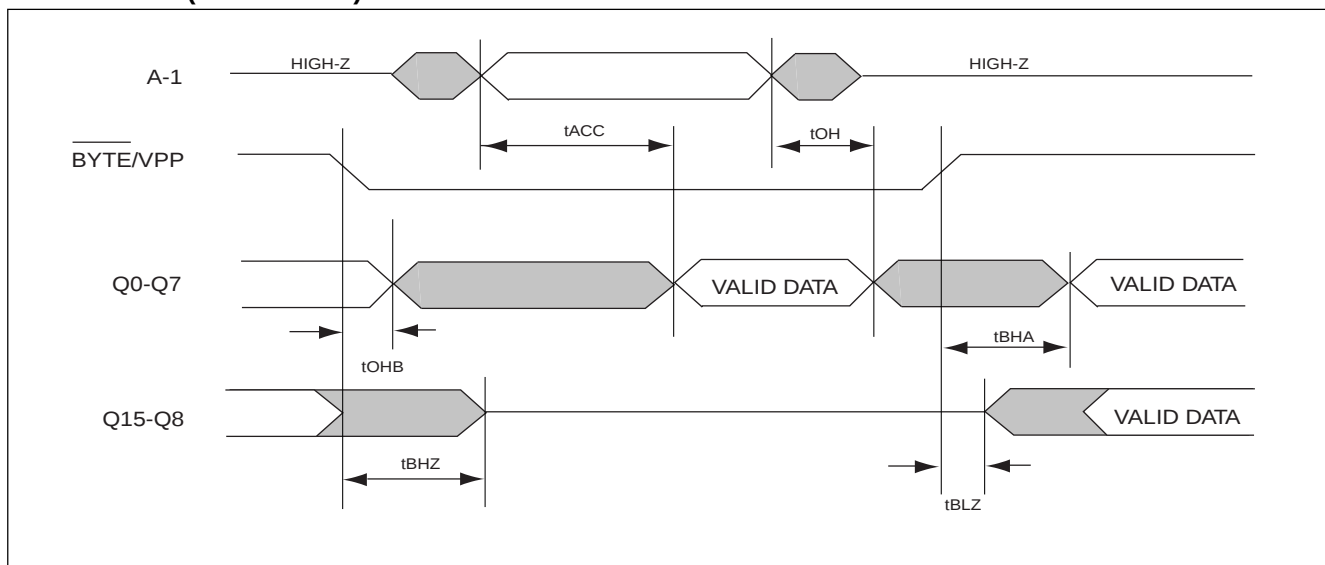


## FAST PROGRAMMING ALGORITHM WAVEFORMS

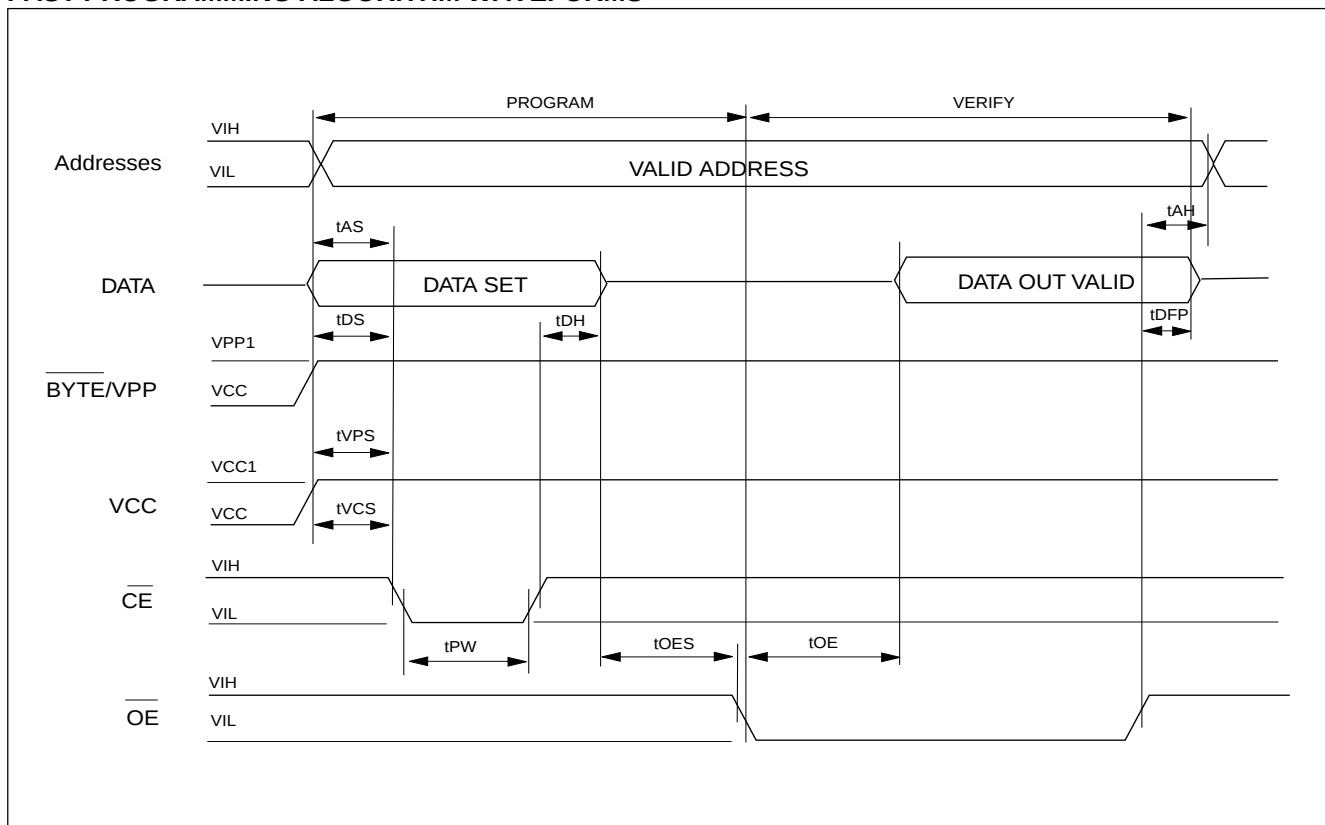


## WAVEFORMS(MX27C4100)

### READ CYCLE (BYTE MODE)



## FAST PROGRAMMING ALGORITHM WAVEFORMS





# MX27C4100/27C4096

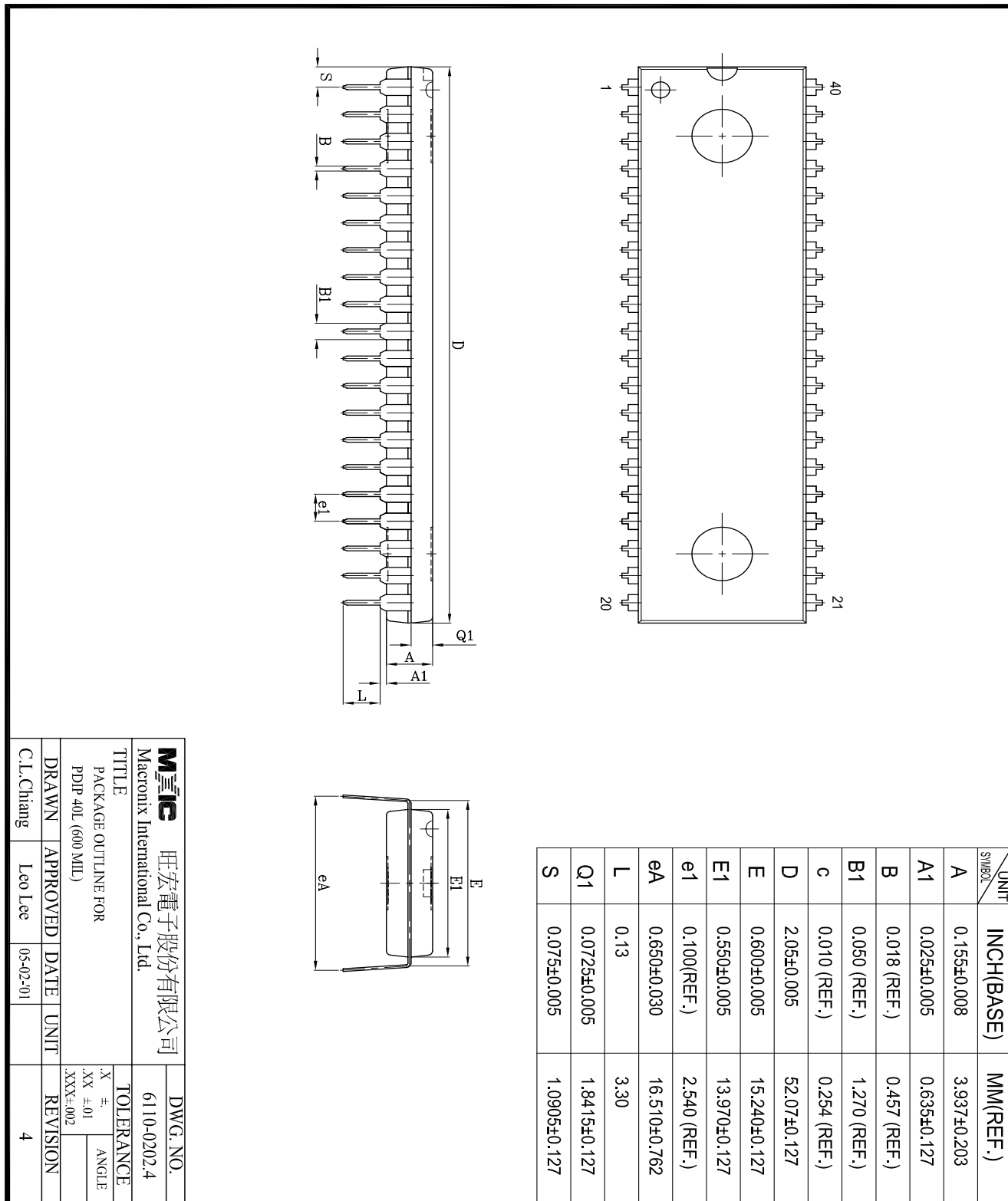
## ORDERING INFORMATION

### PLASTIC PACKAGE

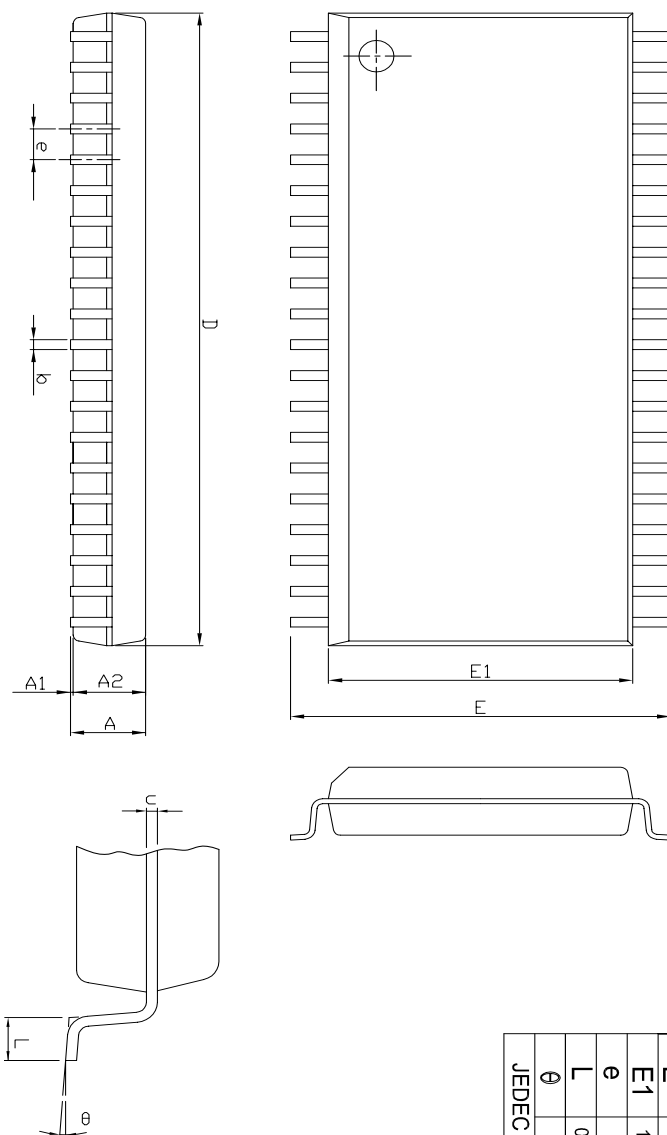
| PART NO.       | ACCESS TIME<br>(ns) | OPERATING<br>CURRENT MAX.(mA) | STANDBY<br>CURRENT MAX.(uA) | OPERATING<br>TEMPERATURE | PACKAGE                   |
|----------------|---------------------|-------------------------------|-----------------------------|--------------------------|---------------------------|
| MX27C4100PC-10 | 100                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(ROM pin out)   |
| MX27C4100PC-12 | 120                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(ROM pin out)   |
| MX27C4100PC-15 | 150                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(ROM pin out)   |
| MX27C4100MC-10 | 100                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin SOP(ROM pin out)   |
| MX27C4100MC-12 | 120                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin SOP(ROM pin out)   |
| MX27C4100MC-15 | 150                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin SOP(ROM pin out)   |
| MX27C4096PC-10 | 100                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(JEDEC pin out) |
| MX27C4096PC-12 | 120                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(JEDEC pin out) |
| MX27C4096PC-15 | 150                 | 60                            | 100                         | 0°C to 70°C              | 40 Pin DIP(JEDEC pin out) |
| MX27C4096QC-10 | 100                 | 60                            | 100                         | 0°C to 70°C              | 44 Pin PLCC               |
| MX27C4096QC-12 | 120                 | 60                            | 100                         | 0°C to 70°C              | 44 Pin PLCC               |
| MX27C4096QC-15 | 150                 | 60                            | 100                         | 0°C to 70°C              | 44 Pin PLCC               |
| MX27C4100PI-10 | 100                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(ROM pin out)   |
| MX27C4100PI-12 | 120                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(ROM pin out)   |
| MX27C4100PI-15 | 150                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(ROM pin out)   |
| MX27C4100MI-10 | 100                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin SOP(ROM pin out)   |
| MX27C4100MI-12 | 120                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin SOP(ROM pin out)   |
| MX27C4100MI-15 | 150                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin SOP(ROM pin out)   |
| MX27C4096PI-10 | 100                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(JEDEC pin out) |
| MX27C4096PI-12 | 120                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(JEDEC pin out) |
| MX27C4096PI-15 | 150                 | 60                            | 100                         | -40°C to 85°C            | 40 Pin DIP(JEDEC pin out) |
| MX27C4096QI-10 | 100                 | 60                            | 100                         | -40°C to 85°C            | 44 Pin PLCC               |
| MX27C4096QI-12 | 120                 | 60                            | 100                         | -40°C to 85°C            | 44 Pin PLCC               |
| MX27C4096QI-15 | 150                 | 60                            | 100                         | -40°C to 85°C            | 44 Pin PLCC               |

## PACKAGE INFORMATION

40-PIN PLASTIC DIP(600 mil)



## 40-PIN PLASTIC SOP(450 mil)

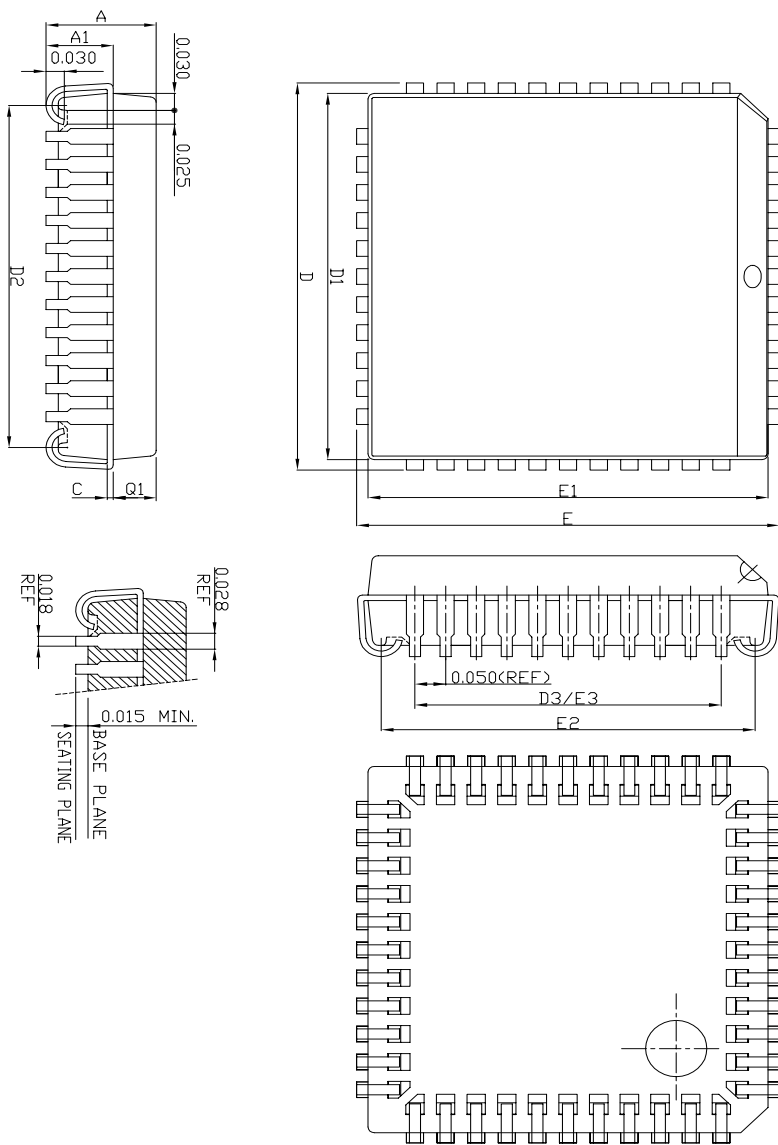


| Symbol | Dimension in mm (Base) |       |       | Dimension in inch (Ref.) |       |       |
|--------|------------------------|-------|-------|--------------------------|-------|-------|
|        | Min                    | Norm  | Max   | Min                      | Norm  | Max   |
| A      | —                      | —     | 3.00  | —                        | —     | 0.118 |
| A1     | 0.10                   | —     | —     | 0.004                    | —     | —     |
| A2     | 2.57                   | 2.69  | 2.82  | 0.101                    | 0.106 | 0.111 |
| b      | 0.41 REF               |       |       | 0.016 REF                |       |       |
| c      | 0.20 REF               |       |       | 0.008 REF                |       |       |
| D      | 25.93                  | 26.06 | 26.19 | 1.021                    | 1.026 | 1.031 |
| E      | 13.87                  | 14.12 | 14.38 | 0.546                    | 0.556 | 0.566 |
| E1     | 11.18                  | 11.30 | 11.43 | 0.440                    | 0.445 | 0.450 |
| e      | 1.27 REF               |       |       | 0.050 REF                |       |       |
| L      | 0.58                   | 0.79  | 0.99  | 0.023                    | 0.031 | 0.039 |
| θ      | —                      | 5°    | —     | —                        | 5°    | —     |

JEDEC

|                                  |  |  |  |             |  |
|----------------------------------|--|--|--|-------------|--|
| <b>MxIC</b> 旺宏電子股份有限公司           |  |  |  | DWG. NO.    |  |
| Macronix International Co., Ltd. |  |  |  | 6110-0206.1 |  |
| TITLE PACKAGE OUTLINE FOR        |  |  |  | TOLERANCE   |  |
| SOP 40L (450 MIL)                |  |  |  | .XX ±.01    |  |
| DRAWN C.L. Chiang                |  |  |  | REVISION    |  |
| APPROVED Dennis Chang            |  |  |  | 1           |  |
| DATE 05-03-01                    |  |  |  | ROUGHNESS   |  |
| UNIT INCH                        |  |  |  | .XXX±.002   |  |

## 44-PIN PLASTIC LEADED CHIP CARRIER(PLCC)



| Symbol | Dimension in inch (Ref.) |            |       | Dimension in mm (Base) |            |       |
|--------|--------------------------|------------|-------|------------------------|------------|-------|
|        | Min                      | Nom        | Max   | Min                    | Nom        | Max   |
| A      |                          |            | 0.180 |                        |            | 4.57  |
| A1     | 0.100                    | 0.105      | 0.110 | 2.54                   | 2.67       | 2.79  |
| Q1     | 0.068                    | 0.070      | 0.072 | 1.73                   | 1.78       | 1.83  |
| C      |                          | 0.010(REF) |       |                        | 0.25(REF)  |       |
| D      | 0.685                    | 0.690      | 0.695 | 17.40                  | 17.53      | 17.65 |
| D1     | 0.650                    | 0.653      | 0.656 | 16.51                  | 16.59      | 16.66 |
| D2     | 0.600                    | 0.610      | 0.620 | 15.24                  | 15.49      | 15.75 |
| D3     |                          | 0.500(REF) |       |                        | 12.70(REF) |       |
| E      | 0.685                    | 0.690      | 0.695 | 17.40                  | 17.53      | 17.65 |
| E1     | 0.650                    | 0.653      | 0.656 | 16.51                  | 16.59      | 16.66 |
| E2     | 0.600                    | 0.610      | 0.620 | 15.24                  | 15.49      | 15.75 |
| E3     |                          | 0.500(REF) |       |                        | 12.70(REF) |       |

REFERENCE DOCUMENT : JEDEC SPEC -MS-016a

|                                  |  |  |  |              |  |
|----------------------------------|--|--|--|--------------|--|
| <b>Mxic</b> 旺宏電子股份有限公司           |  |  |  | DWG. NO.     |  |
| Macronix International Co., Ltd. |  |  |  | 6110-0209.3  |  |
| TITLE                            |  |  |  | TOLERANCE    |  |
| PACKAGE OUTLINE FOR              |  |  |  | X ±.         |  |
| PLCC 44L                         |  |  |  | XX ±.01      |  |
| DRAWN                            |  |  |  | .XXX±.002    |  |
| APPROVED                         |  |  |  | ANGLE        |  |
| DATE                             |  |  |  | ±2°          |  |
| UNIT                             |  |  |  | REVISION     |  |
| inch                             |  |  |  | 2            |  |
| C.L.Chang                        |  |  |  | Dennis Chang |  |
| 05-03-01                         |  |  |  |              |  |



## Revision History

| Revision No. | Description                                                                                          | Pgae         | Date        |
|--------------|------------------------------------------------------------------------------------------------------|--------------|-------------|
| 3.0          | 1) Eliminate Interactive Programming Mode<br>2) 40-CDIP package quartz lens, change to square shape. |              | 6/13/1997   |
| 3.1          | IPP1 100uA to 10uA                                                                                   |              | 7/17/1997   |
| 3.2          | Cancel 32pin ceramic DIP Package                                                                     | P1,2,4,13,14 | FEB/25/2000 |
| 3.3          | Modify Commercial range 0~55°C-->0~70°C                                                              | P9           | MAY/03/2000 |
| 3.4          | Cancel "Ultraviolet Erasable" wording in General Description<br>To modify Package Information        | P1<br>P14~16 | AUG/22/2001 |



**MX27C4100/27C4096**

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